20.1 Design of an 8-wide Superscalar RISC Microprocessor with Simultaneous Multithreading

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Outline

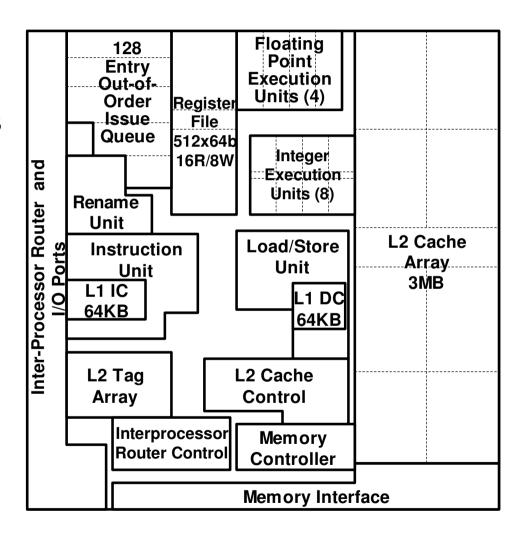
- Project Goals and Chip Overview
- 8-wide Superscalar Issue
 - Instruction Cache
 - Collapsing Buffer
- Simultaneous Multithreading
 - Register File
- Process Technology
 - Interconnect Issues and Migratability
 - SOI Pass Gate Effect and Examples
- Summary

Project Goals

- Performance improvement vs. previous design¹
 - 2X improvement in single stream performance.
 - Additional 2X improvement in instruction throughput with Simultaneous Multithreading (SMT)
- Reduced system development cost
 - Reuse of interprocessor and memory interfaces from previous design.
- Design longevity
 - 1st tapeout in 0.13μm SOI with Cu interconnect
 - Migration path to 0.1μm and 0.07μm for production
 - Option for larger L2 cache at 0.1μm/0.07μm

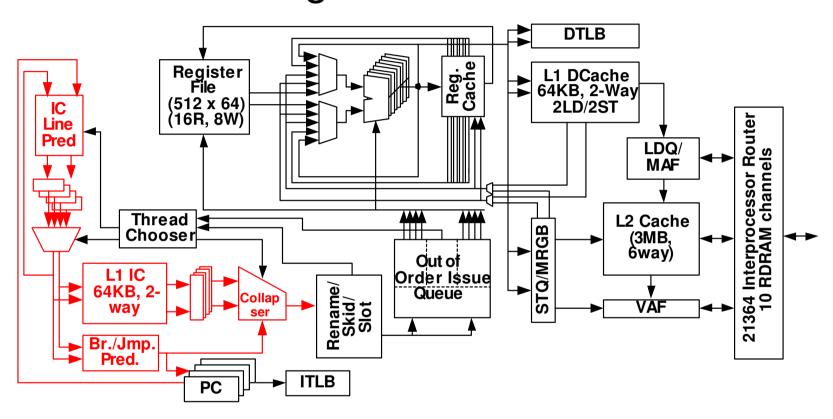
Chip Overview

- Microarchitecture
 - 8-way Superscalar
 - 4-way Simultaneous Multithreading
 - On-chip L2 cache
 - Glueless ccNUMA
 - Memory Controller
- Physical Design (estimated values)
 - .13µm SOI process
 - 250M transistors
 - $-4cm^2$ (19 x 21 mm)
 - 150 Watts at 1.1V
 and 1.8GHz



8-wide Superscalar Issue

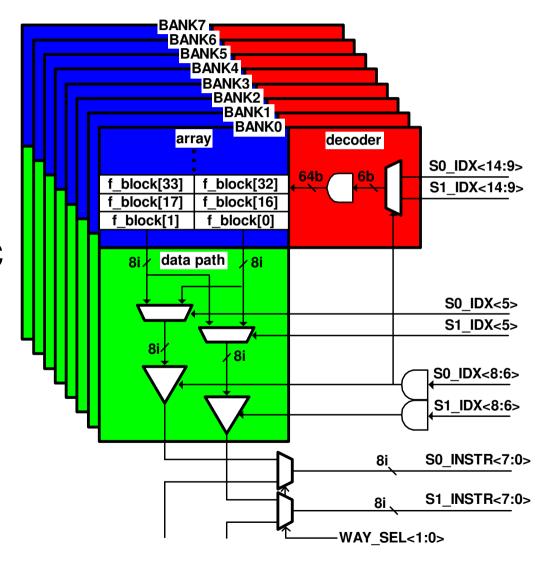
Assembling the Instruction Block



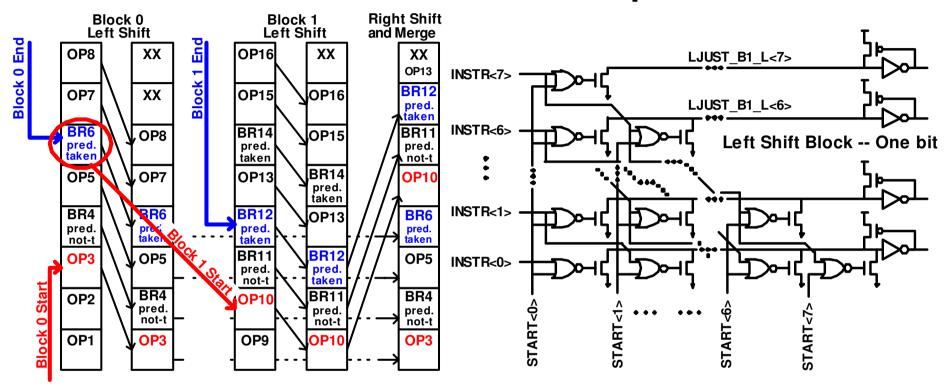
- IC Line predictor selects 2 IC fetch blocks/cycle
- Banked 64KB Icache to allow 2 fetches
- Collapser compresses 2 fetch blocks into a single block
- Branch predictor predicts up to 2 taken branches/cycle

Instruction Cache

- Predictor produces
 2 fetch indices
 - Indices point into aligned blocks of 8 instructions
 - Sequential indices map to the same IC word line or to adjacent banks.
- Fetch conflicts
 - Occur only on nonsequential indices
 - Can not occur on short branches



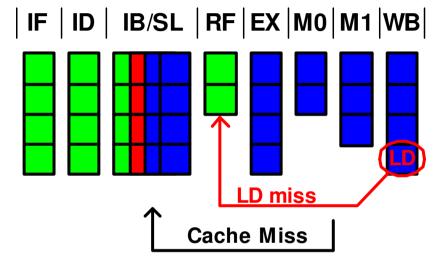
Instruction Collapser



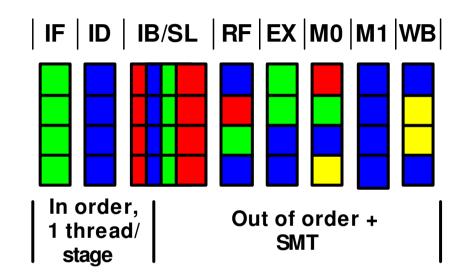
- Operation
 - Update pointers, Left Shift to justify, Right Shift/Merge
- Circuit Implementation
 - Bit Interleaved layout, 1-hot shift controls
 - 1 high dynamic pull downs, high-Vt/long-channel

Simultaneous Multithreading

Switch on Event Multithreading

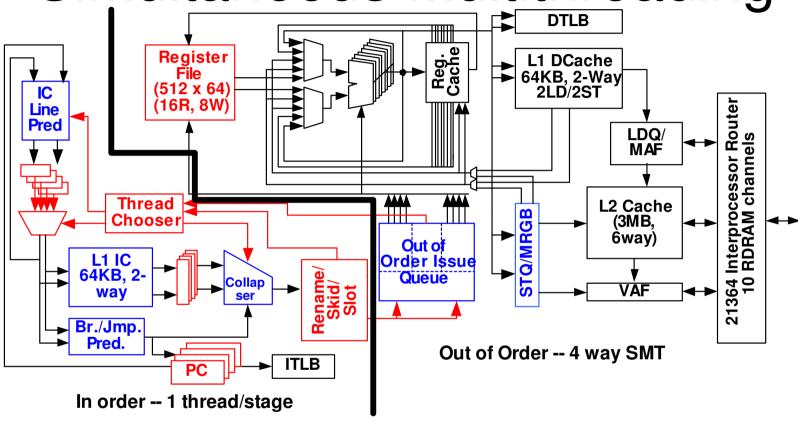


Simultaneous Multithreading



- Switch on Event Multithreading (SoEMT)
 - Can hide cache miss latency¹
- Simultaneous Multithreading (SMT)
 - Hides cache miss latency
 - Improves throughput when ILP is < issue width
 - Natural extension of OoO execution model

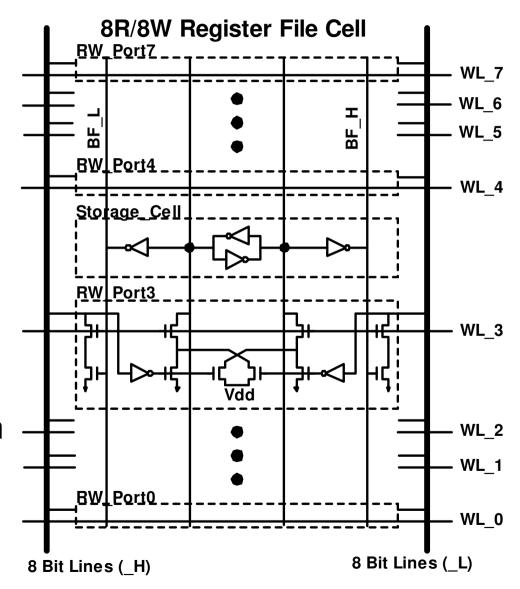
Simultaneous Multithreading



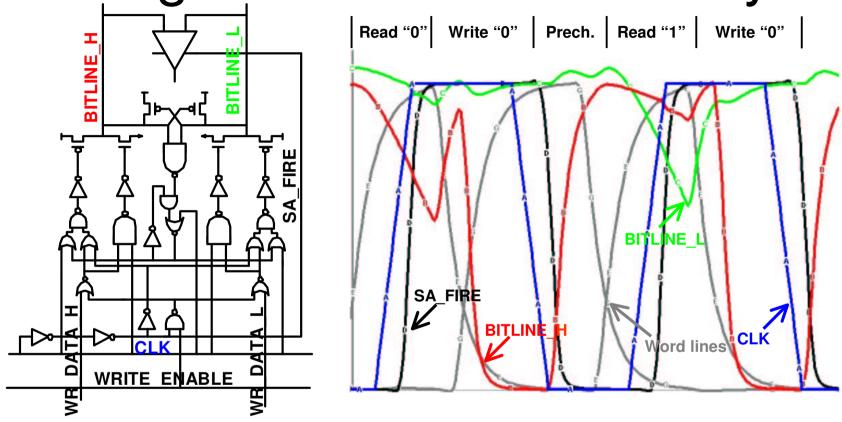
- Additional architectural state elements / thread
 - 32 GPRs, 32 FPRs, PCs, etc.
- Heuristic thread choosers, buffers, and muxes.
- Numerous small changes
- SMT requires <10% additional core die area

Register File

- 8-wide issue
 - 8 Write ports
 - 16 Read Ports
- 4-way SMT
 - 64 registers / thread
- +256 inflight results
- Implementation
 - 2 banks, 8RW ports
 - 1024 registers total
 - Differential pull-down read
 - DCVSL write with local inverter receiver



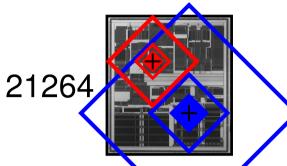
Register File R/W Circuitry



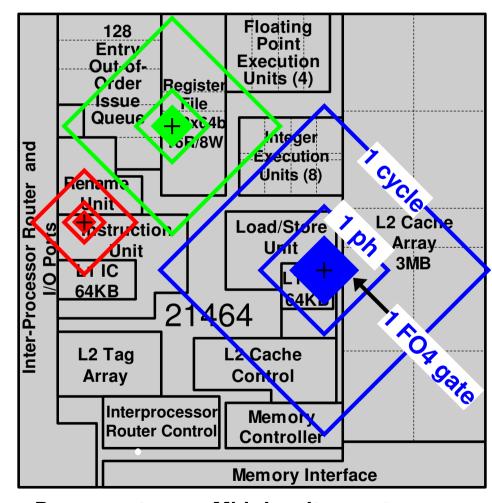
- Precharge starts with falling CLK, ended when precharge detected
- Read differential starts in late "B" phase
- Sense Amp fire CLK+2 gates
- Write enabled at SA_FIRE+4 gates

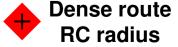
Process Technology

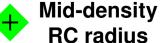
Interconnect delay issues



- Large CRU core
 - ~ 8X the design unit size of the 21264
 - >1 cycle RC delays across core using "best" metal
- RC routing delays
 - + Cu / lower-K
 - Equal design unit RC delays



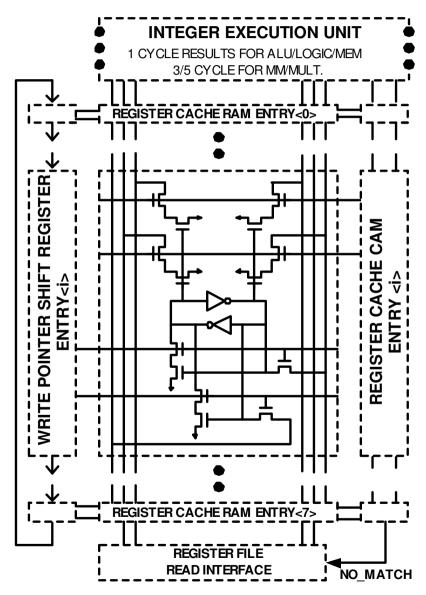






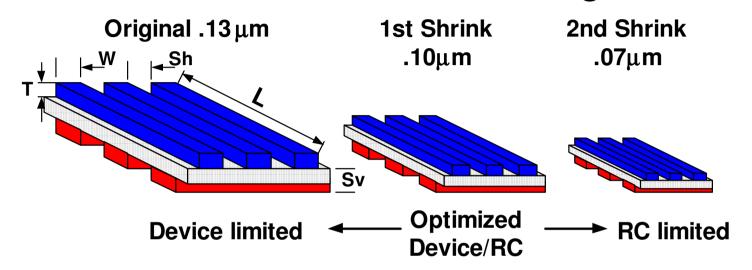
Register Cache

- Register Cache
 - Stores recent results locally at the functional unit
 - Hides multi-cycle RC delay to/from main RF
 - Aligns write-back to the register file
- CAM/RAM structure
 - CAMs identify physical register address for subsequent reads
 - Shift register write pointer



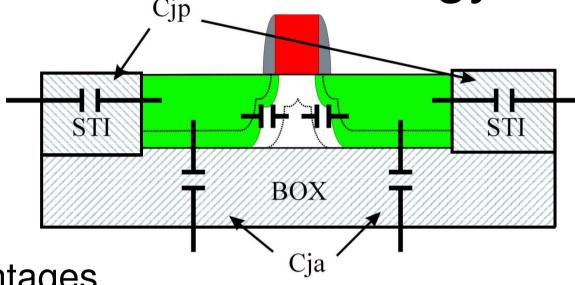
Process Migratability

Interconnect modeling



- RC delays don't scale with process migrations
 - + R varies with L / (W * T)
 - C varies with (L * T) / Sh and (L* W) / Sv
 - ~ RC delays are constant
- Target for best balance in the 2nd process
 - Increase effective ρ for initial design in .13 μ m
 - Allocate repeaters and latches for new target process

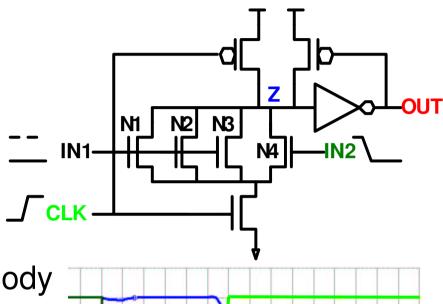
SOI Technology

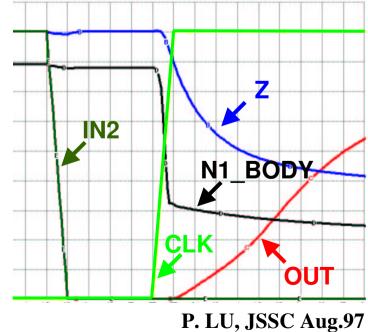


- Advantages
 - Higher device performance
 - Reduced junction capacitance
 - Increased Ids from positive Vbs
- Disadvantages
 - History effect typically <10% variation due to FBE
 - Increased device leakage
 - Pass gate effect limits on dynamic/pass gate circuits

Pass-Gate Effect

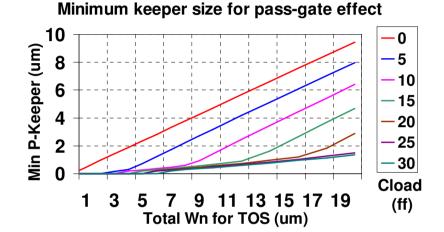
- Floating body charging
 - Impact ionization
 - Junction leakage
 - S/D coupling
- Source transition (H->L)
 - Capacitively couples to Body
 - Body falls
 - Body couples to Drain
 - Charge loss from Drain
 - May also trigger NPN
- Susceptible circuits
 - Pass gates
 - Dynamic logic

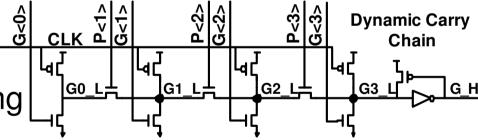


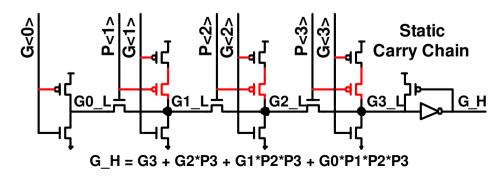


Pass-Gate Effect Solutions

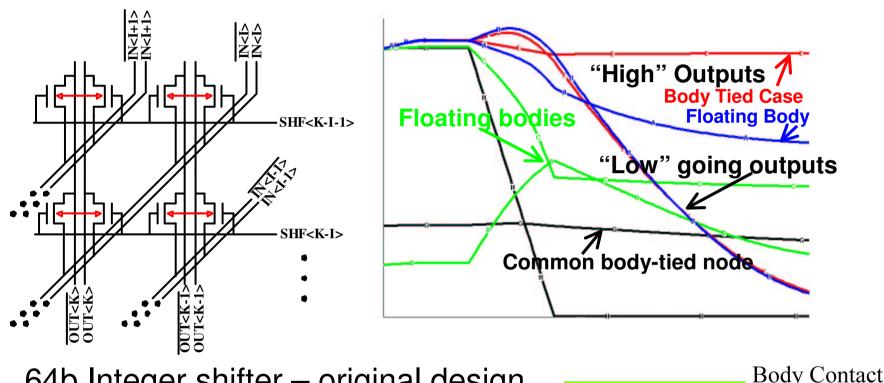
- Limits on fan-in
- Keeper sizing
 - Trades W of top-of-stack against P-keeper and C_{load}
- Topology fixes
 - Trade chg. share vs. pass-gate effect
 - Stack reversal, swizzling
 - Predischarge
- Static alternatives
- Body contacts
 - Limited use







64b Integer Shifter Solution



- 64b Integer shifter original design
 - Dual-rail pass gate mux
 - Large pass-gate effect
- Solution
 - Use body-contacts to cross tie devices
 - Body coupling to "common" nodes is largely offset.

Summary

- Proposed new CPU with a 2X performance increase over the previous design
 - 8 wide Superscalar issue
 - Banked ICache supporting 2 fetches/cycle.
 - Collapser produces single block of 8 instr./cycle
 - 4-way Simultaneous Multithreading
 - Increases instruction throughput 2X over single threaded design.
 - OoO Execution model supports SMT with <10% additional hardware
 - Process technology issues
 - Targeted interconnect modeling to 2nd process
 - SOI Pass Gate effect mitigated with a variety of techniques

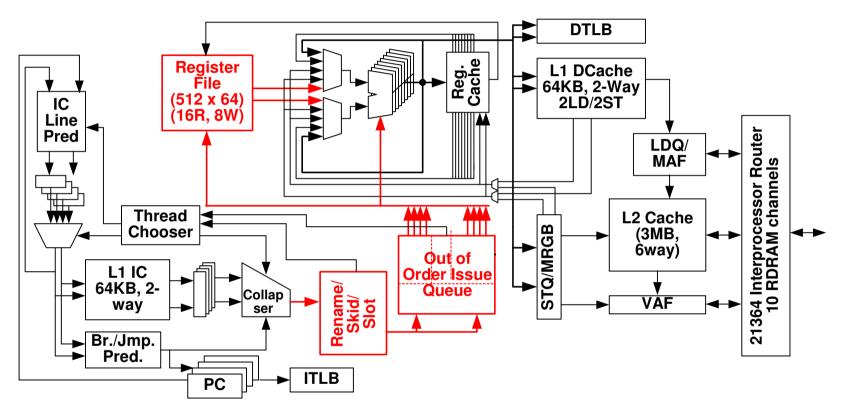
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Deleted Slides

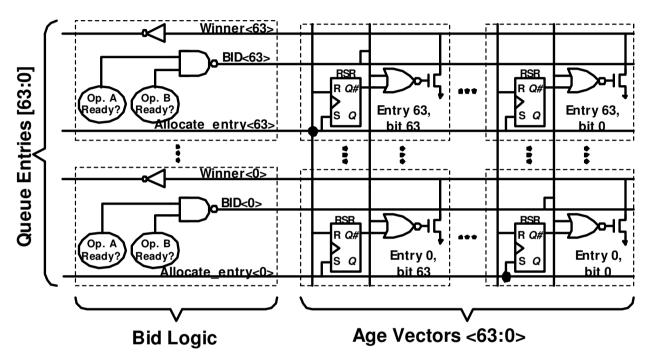
8-wide Superscalar Issue

Instruction issue and execution



- Renamer maps operands/dests into physical registers
 - Physical register space covers up to 256 in-flight instr.
- Instr. slotted to a "picker" in ½ of the 128 entry queue
- OoO issue queue picks up to 8 issue ready instructions

Issue Queue



- Entering instructions allocate an entry
 - Set a new AgeVector with a "0" in their "own" position
 - Clear the corresponding bit in all other AgeVectors
- Bidding
 - All ready instructions bid on their pipeline set.
 - AgeVector finds the "oldest" bidding instruction